



Degradation by design: sequentially degradable organic transistors for sustainable electronics

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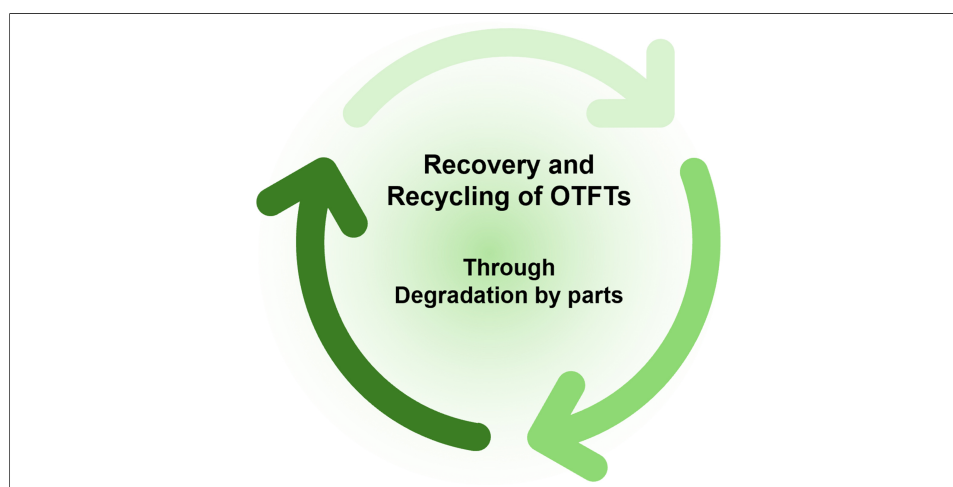
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Abstract

The growing accumulation of electronic waste (e-waste) and demand for environmentally sustainable technologies have accelerated interest in transient degradable electronics, which physically disintegrate or biodegrade after their functional lifetime. Such devices offer promising pathways towards reducing ecological impact while enabling applications in biomedical implants, environmental sensors, and temporary wearable systems. Biodegradable organic thin-film transistors (OTFTs) play a pivotal role as fundamental building blocks for fully transient electronic circuits, combining mechanical flexibility, solution processability, and controlled disintegration. In this study, we report the development of a fully degradable OTFT fabricated using diketopyrrolopyrrole thiophene-imine-thiophene as the biodegradable semiconducting layer, integrated with a bilayer dielectric composed of poly(vinyl alcohol) (PVA) and poly(caprolactone) (PCL), and a poly(lactic acid) (PLA) substrate. This configuration yields a significant reduction in threshold voltage (V_T) from -16.1 to -2 V compared to devices fabricated on octyltrichlorosilane/ SiO_2 , while maintaining comparable charge carrier mobility. The OTFT can be selectively degraded through sequential steps, where the semiconductor dissolves



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under acidic conditions (1 M HCl), followed by degradation of the dielectric and substrate in basic buffer solution. This controlled disassembly enables separation and potential recycling of individual components, providing a straightforward strategy for environmentally responsible end-of-life management of transient electronics. Overall, this work represents an important step toward realizing low-voltage, fully degradable, and recyclable electronic systems for sustainable applications.

INTRODUCTION

The rapid growth of electronic devices across biomedical, environmental, and consumer applications has intensified concerns over electronic waste (e-waste) and the long-term persistence of electronic materials. Transient electronics address this challenge by incorporating materials that undergo controlled degradation after use, thereby reducing waste accumulation and environmental impact^[1-3]. These biodegradable electronics have several advantages, such as (i) lowering the amount of e-waste that accumulates; (ii) circumventing invasive surgeries to remove implanted devices; and (iii) enabling environmental transience, which allows sensors that are deployed remotely to function without retrieval^[4-7]. Organic thin-film transistors (OTFTs) are electronic building blocks for circuits with applications in biological and chemical sensors^[8], health monitoring systems^[9], stretchable electronics^[10], and electronic skin^[11]. While advances in materials design have greatly improved OTFT performance, the environmental and biological safety of these materials remain underexplored^[12,13].

Advancing transient OTFT requires deliberate design and scalable fabrication of each component and layer to ensure both performance and sustainability^[14-17]. Lei *et al.* demonstrated the fabrication of a biocompatible and fully disintegrable OTFT, with respectable charge carrier mobility, using a semiconducting polymer with iron electrodes and a cellulose substrate^[18]. They reported complete disintegration of their OTFTs in acidic conditions after 30 days *in-vitro*. However, when all components degrade simultaneously in a single environment, it becomes difficult to separate, isolate, or recycle functional materials. Thus, advancing fully transient electronics requires OTFTs in which each component responds to distinct degradation triggers, enabling controlled disassembly and targeted recovery of valuable resources like gold/precious metals.

The substrate, which accounts for 99.89% of the overall device mass^[19], must be a biodegradable plastic. Biobased materials such as poly(lactic acid) (PLA), polyhydroxyalkanoates (PHAs), starch blends, and cellulose-derived polymers are promising substrate options, contingent upon processing temperatures not exceeding ~ 150 °C^[20]. However, biodegradable dielectrics exhibiting appropriate physical and electrical properties remain limited. Poly(vinyl alcohol) (PVA) [Figure 1] is a bioresorbable dielectric that rapidly dissolves in environmentally benign solvents such as water and undergoes natural degradation when exposed to suitable bacteria^[21]. PVA has been utilized as a dielectric in sensors and OTFTs, either in its pure polymer form or in combination with other materials^[22-24]. Despite its benefits, PVA presents challenges: printing frequently necessitates optimization, such as the incorporation of viscosity enhancers, and its hydrophilic characteristics render the resultant films susceptible to moisture, undermining device stability and reliability^[25,26]. Previously, our group demonstrated that combining PVA with an interfacial, thermally crosslinked diisocyanate-terminated poly(caprolactone) (TPCL) yields a high-performance, hydrophobic, and degradable high-k/low-k bilayer dielectric^[27,28]. This architecture couples the high dielectric constant and electrical performance of PVA with the moisture resistance of poly(caprolactone) (PCL), while also improving surface compatibility for semiconductor deposition^[29,30]. To enhance shelf stability and enable scalable processing, we further synthesized benzodioxinone-terminated PCL, which can be ultraviolet (UV)-coupled to the PVA surface [Figure 1]^[24,26]. PLA, PVA, and PCL are inexpensive, widely available, and have a long history of use in biomedical devices within clinical practice^[19].

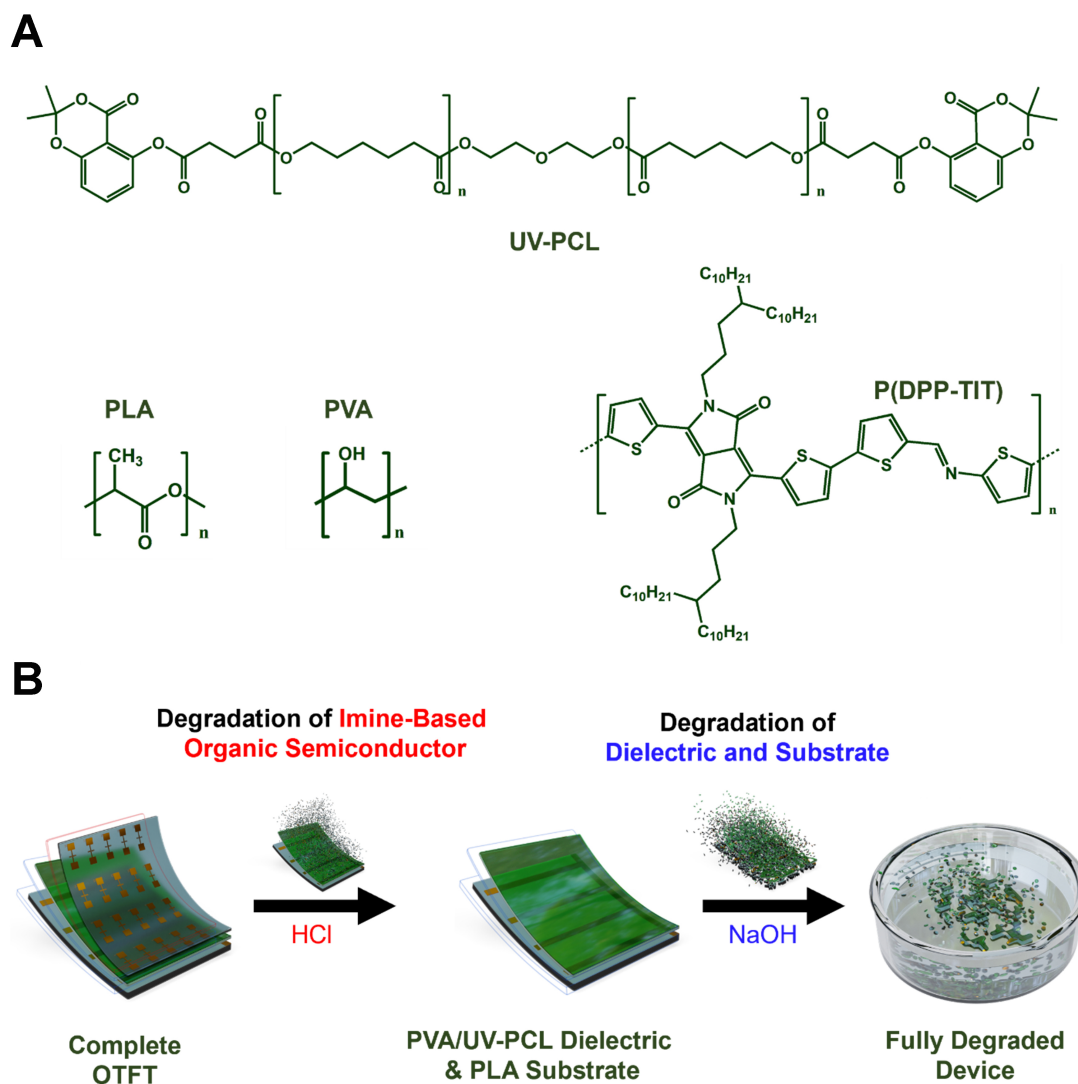


Figure 1. (A) Chemical structures of biodegradable polymers: PLA, PVA, benzodioxinone-terminated poly caprolactone (UV-PCL), and P(DPP-TIT); (B) Schematic illustration of the sequential degradation of an OTFT device. All elements in this figure were developed using ChemDraw and Blender. PLA: Poly(lactic acid); PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone); P(DPP-TIT): poly diketopyrrolopyrrole-thiophene-imine-thiophene; OTFT: organic thin-film transistor.

A diverse array of processing and synthetic strategies have been developed and optimized towards designing transient organic semiconductors, primarily focused integrating and balancing electronic functionality with environmental instability^[31]. These approaches include encapsulation of semiconducting fillers within biodegradable polymer matrices, the synthesis of block copolymers featuring discrete semiconducting and degradable segments, the utilization of naturally occurring pigments susceptible to enzymatic breakdown, and the covalent tethering of conjugated motifs to degradable scaffolds via chemically cleavable linkages^[32–34]. Among these strategies, the integration of acid-labile imine motifs directly within the backbone of organic conjugated polymers is a promising approach for designing materials possessing good electronic performance while also foregoing the requirement of complicated degradation triggers^[18,35]. Compared to other strategies which rely on either disrupting the conjugated backbone or reducing the amount of semiconducting material within the device's active layer, imine-motifs possess sp^2 -hybridization character, allowing for the double-bond to contribute and maintain the orbital delocalization of the conjugated polymer backbone, a parameter critical for obtaining good charge carrier mobility in OTFTs^[36–38]. Furthermore, compared to other synthetic approaches for designing transient organic semiconductors,

imine-based conjugated polymers do not require complicated synthetic protocols or specialized processing procedures, and have shown potential promise for greener synthetic pathways in developing organic semiconductors^[39,40]. When paired with an established high charge carrier performance chemical structure, particularly diketopyrrolopyrrole (DPP), it has been demonstrated that imine-based conjugated polymers can be used to fabricate high performance transient OTFTs with measurable electronic properties comparable to conventionally used designs^[37]. In addition to possessing good charge carrier mobility in OTFTs, DPP-based polymers have well-understood aqueous and photo-degradation mechanisms, further enforcing their role as promising chemical motifs for designing transient devices that are also environmentally benign^[41,42]. Inspired by previous reports, DPP was copolymerized with a thiophene-imine-thiophene donor monomer to generate poly diketopyrrolopyrrole thiophene-imine-thiophene [P(DPP-TIT)], a conjugated polymer established to have good hole charge carrier mobility in OTFTs^[36,43].

To further synergize good electronic performance with degradation capabilities, we report a novel variant of P(DPP-TIT), as per [Figure 1](#), designed with alkyl side chains where each branching arm symmetrical carbon lengths, a structural feature known to enhance charge transport in thin films while simultaneously limiting excessive molecular weight growth during polymerization, allowing for relatively narrow dispersity in polycondensation-type reactions^[44,45]. The combination of narrow dispersity and lower molecular weight of the organic semiconductor has implications in accelerating degradation time, a highly sought after trait in transient electronic technologies^[46]. By integrating the P(DPP-TIT) conjugated polymer with degradable polymeric substrates and dielectric layers, it is possible to design fully transient OTFTs that exhibit strong electrical performance while producing benign by-products during degradation. The combination of materials with distinct degradation triggers enables controlled, multi-step disassembly that allows selective breakdown, separation, and potential recycling of individual layers. Finally, incorporating biocompatible, non-toxic electrodes alongside these materials completes the foundation for fully biodegradable and biocompatible electronic devices. We have previously fabricated cytocompatible and disintegrable OTFTs using gold electrodes; however, the gold electrodes did not degrade and therefore required recovery^[24]. Gold combines high electrical conductivity and excellent biocompatibility in both *in vitro* and *in vivo* environments, and is well-established role in various medical technologies^[47-49]. Furthermore, as an inert biomaterial, gold has proven effective in reducing biofouling in biological systems^[50], particularly in implants such as cardiovascular devices and biomedical microelectromechanical systems (BioMEMS)^[51].

This study presents a fully degradable and biocompatible *p*-type OTFT with high mobility and low threshold voltage (V_T), based on a P(DPP-TIT) conjugated polymer integrated with a biodegradable PLA substrate and a bilayer PVA/UV-PCL dielectric. Low-temperature surface engineering strategies, including the deposition of biodegradable hydrophobic interlayers, were employed to improve film quality and device reproducibility. Electrical performance and stability were benchmarked against conventional OTFT architectures, confirming competitive operation while highlighting the advantages of sustainable materials. Distinct from previous reports, each device component in this system degrades under a specific pH trigger, enabling sequential disassembly and selective recovery of individual layers [[Figure 1B](#)]. The imine-containing P(DPP-TIT) semiconductor dissolves under acidic conditions, whereas the PLA substrate and dielectric degrade in basic environments, allowing controlled separation and recycling. This dual-trigger design establishes a new paradigm for transient optoelectronics, demonstrating how performance and sustainability can be co-engineered through programmable end-of-life disassembly.

EXPERIMENTAL

Materials

All reagents were acquired from Sigma-Aldrich and utilised without additional purification unless specified differently. Octyltrichlorosilane (OTS, 97%) was dissolved in anhydrous toluene (99.8%) inside a glovebox to prepare a 1% v/v solution. PCL diol (Mw = 2,000 Da), toluene-2,4-diisocyanate (95%), PLA (230 kg·mol⁻¹), and PVA (Mw = 31,000–50,000 Da; 98%–99% hydrolyzed) were procured from Sigma-Aldrich. Chromium-coated tungsten rods and high-purity gold (Au, 99.99%) were obtained from Angstrom Engineering. Quartz-coated glass substrates (15 × 20 mm²) were acquired from Ossila Limited, whereas Si wafers featuring a 230 nm SiO₂ layer and shadow masks were provided by WaferPro and Ossila Limited, respectively. Deuterated chloroform (99.8% purity) and benzene (98% purity) were obtained from Cambridge Isotope Laboratories Inc. The synthesis of P(DPP-TIT) was conducted according to established protocols, and 2,2-dimethyl benzodioxinone-terminated PCL (UV-PCL) was synthesised using documented methods^[27].

Gel permeation chromatography

Number average molecular weight (Mn), weight average molecular weight (Mw), and polydispersity index (PDI) of P(DPP-TIT) were evaluated by high temperature size exclusion chromatography (SEC) [Supplementary Figure 1 and Supplementary Table 1] using 1,2,4-trichlorobenzene (TCB) and performed on S-3 an EcoSEC HLC-8321GPC/HT (Tosoh Bioscience, Japan) equipped with a single TSKgel GPC column (GMHHR-H; 300 mm × 7.8 mm) calibrated with monodisperse polystyrene standards. The samples were prepared using 1 mg/mL of sample in TCB, which were allowed to stir at 80 °C for 12 h prior to injection. The analysis of the samples was performed at 180 °C with a flow rate of 1.0 mL/min with injection quantities of 300 µL. The data was collected and integrated using EcoSEC 8321GPC HT software suite.

Preparation of the substrate and dielectric

The Substrate (PLA) and dielectric (PVA/UV-PCL) solutions were prepared following the protocol reported in our previous study^[24]. Briefly, the materials were dissolved in the appropriate solvent systems under continuous stirring until complete homogenization was achieved. The processing conditions, including concentration, temperature, and mixing duration, were maintained consistent with the previously optimized procedure. Detailed processing parameters and preparation steps can be found in our earlier publication^[24].

Fabrication of OTFTs

Glass substrates (15 × 20 mm²) coated with quartz were used as temporary supports for the fabrication of OTFTs. Substrate cleaning and preparation were carried out according to the protocol described in our previous study^[52].

A spin coater [Laurell WS-650-23, United States of America (USA)] was used to spin-coat the PLA solution in chloroform (70 mg/mL) filtered through 0.22-micron polytetrafluoroethylene (PTFE) filters, onto the cleaned substrates for 90 s at 1,200 rpm. The substrates were then vacuum annealed for 15 min at 70 °C. PLA films with a thickness of roughly 2 µm were produced by this method. The gate electrodes were deposited using a thermal evaporator (Angstrom Evovac, Canada), consisting of a 2 nm chromium (Cr) adhesion layer (0.5 Å·s⁻¹) and a 50 nm gold (Au) layer (0.5 Å·s⁻¹) applied to the PLA film through a shadow mask. After that, the PLA substrates coated with Cr/Au were air-plasma-treated using PDC-32G plasma cleaner (Harrick Plasma, USA) for 15 min, followed by rinsing with isopropanol and water, which improved surface wettability. Next, the biodegradable bilayer dielectric layers were deposited following our previously reported procedure^[24]. After crosslinking the degradable semiconducting layer was deposited by spin-coating a 3 mg/mL solution of P(DPP-TIT) dissolved in chlorobenzene at 2,500 rpm for 60 s, followed by annealing at 50 °C for 1 h in a vacuum oven. The average thickness of the semiconductor layer was measured around

~154 nm. Lastly, the devices were moved to a nitrogen glovebox linked with a thermal evaporator built in. A 50 nm Au layer ($0.5 \text{ \AA}\cdot\text{s}^{-1}$) was deposited via physical vapor deposition (PVD) using a shadow mask to obtain source–drain electrodes. This resulted in channel dimensions of $L = 30 \text{ }\mu\text{m}$ and $W = 1,000 \text{ }\mu\text{m}$. Si wafers were used as substrate and SiO_2 as a nondegradable dielectric in the fabrication of the control OTFT for comparison. Following the same four-step cleaning procedure, the wafers were exposed to air plasma for fifteen minutes. Wafers were immersed in a 1% v/v OTS solution in toluene at $70 \text{ }^\circ\text{C}$ for 1 h. They were then rinsed with toluene and dried in a vacuum oven at $70 \text{ }^\circ\text{C}$. A layer of degradable semiconductor was deposited by spin-coating following surface preparation, and then Au source/drain electrode deposition was carried as previously described.

Device characterization

OTFT were characterized using a Keithley 2614B source meter coupled to a specially designed auto-tester^[53]. The complete device characterization procedure can be found in the [Supplementary Materials](#).

Thin film characterization

Grazing-incidence wide-angle X-ray scattering

Grazing-incidence wide-angle X-ray scattering (GIWAXS) experiments were performed at the SOLEIL Synchrotron facility in Saint-Aubin, France, using the SIRIUS beamline^[54]. The X-ray energy was set to 10 keV ($\lambda = 1.24 \text{ \AA}$) using a Si(111) double-crystal monochromator. The beam had a size of $500 \times 120 \text{ }\mu\text{m}^2$ ($H \times V$), and a beam stop was employed to block the direct and reflected beams. GIWAXS measurements were taken directly from the polymer samples deposited on silicon substrates at an angle of incidence set according to the sample of 0.1° . GIWAXS patterns were collected with a DECTRIS PILATUS3 1M ($172 \times 172 \text{ }\mu\text{m}$ pixel size), which was placed 312 mm from the sample center. The GIWAXS data were then calibrated against a silver behenate and P3HT standard and analyzed using the GIXSGUI software package^[55].

Atomic force microscopy

Atomic force microscopy (AFM) images were taken using an AFM (Bruker Dimension FastScan, USA) with ScanAsyst-Air tips in Peak Force Tapping Mode. Imaging processing was performed with NanoScope Analysis v.3.0. The samples per line used were 512.

Raman spectroscopy

A confocal Raman microscope [Renishaw inVia InSpec, United Kingdom (UK)] was used to record non-polarized Raman spectra, in conjunction with a Leica Microsystems DM2700 bright-field microscope, Germany. Spectra and maps for P(DPP-TIT) films on SiO_2 and bilayer dielectrics were collected in the $500\text{--}2,000 \text{ cm}^{-1}$ range using a 532 nm laser (500 mW) and a $2,400 \text{ L}\cdot\text{mm}^{-1}$ grating. The laser beam was focused onto the sample through a 50 L with a 0.5 aperture integrated into the DM2700 optical system. This setup provided a theoretical depth of focus of approximately $3.0 \text{ }\mu\text{m}$, a spatial resolution of about 640 nm, and a spectral resolution of 0.3 cm^{-1} [full width at half maximum (FWHM)]. Calibration was performed before each measurement using the silicon reference peak at 520 cm^{-1} , maintained within $\pm 0.5 \text{ cm}^{-1}$ accuracy. Raman spectra were collected without polarization at 10% laser power (50 mW) and a 10 s exposure time. Raman mapping ($19 \times 19 \text{ }\mu\text{m}^2$) was performed using 361 individual spectra, acquired with a $1.0 \text{ }\mu\text{m}$ step size, 5% laser power (25 mW), and a 10 s exposure. All data were processed to remove cosmic ray artifacts.

UV-visible spectroscopy

A Cary 6000i UV-Vis-NIR spectrophotometer (Agilent Technologies, Malaysia) was used to collect spectra. Absorbance measurements were collected for solid-state thin films deposited onto a glass substrate via drop casting, followed by annealing at $50 \text{ }^\circ\text{C}$ for 1 h, within the range of 250–1,000 nm.

Table 1. Dielectric properties of bilayer dielectric (PVA/UV-PCL) at 10 Hz

Dielectric	Effective dielectric constant (k)	Capacitance density (nF/cm^2)
PVA/UV-PCL	6.6 ± 3.2	19.7 ± 9.7

PVA: Poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone).

Profilometer

A Dektak XT Profilometer (Bruker Corporation, USA) was used to measure the thickness of the PLA substrates, bilayer dielectrics, and P(DPP-TIT) films.

RESULTS AND DISCUSSION

Fully transient OTFTs were fabricated using biocompatible and biodegradable polymers chosen for their electrical performance, processability, and distinct degradation behavior. The devices feature a bottom-gate, top-contact (BGTC) architecture where [Figure 1](#) shows the chemical structures of the PLA substrate, PVA/UV-PCL bilayer dielectric, and P(DPP-TIT) semiconductor, along with a schematic of the stepwise degradation. A uniform biodegradable PLA film was obtained by spin coating PLA onto a quartz-coated glass substrate which was baked to eliminate residual solvent, following established literature^[56,57]. The resulting PLA substrate was approximately 2 μm thick and was subsequently coated with patterned chromium and gold (Cr/Au) electrodes. The chromium interlayer facilitated strong adhesion between the gold film and the PLA surface and functioned as the bottom gate electrode, ensuring stable and reproducible electrical characterization^[53]. Since the gold-patterned PLA surface exhibited hydrophobic characteristics^[24], air plasma treatment for 15 min was employed to enhance its surface hydrophilicity, thereby facilitating uniform coating of the subsequent dielectric layer. The PVA dielectric layer was deposited by spin-coating on the gold/PLA substrate and was annealed at low temperatures (50 $^{\circ}\text{C}$ for ~ 18 h). We found that exposure of the PLA substrate to temperatures > 50 $^{\circ}\text{C}$ results in dimensional shrinkage, leading to surface buckling and increased roughness, conditions unfavorable for OTFT fabrication^[24]. Hygroscopic polymer dielectrics, such as PVA, can demonstrate a capacitance density enhancement of up to $\times 50$ at 10 Hz upon moisture exposure^[58]. This phenomenon occurs as water functions as a plasticizer, facilitating the alignment of hydroxyl groups in an electric field and thereby augmenting the capacitance of PVA films^[59,60]. However, for flexible electronic circuits, it is essential to preserve constant dielectric characteristics and avoid water uptake. A thin PCL layer (about 1-2 nm) applied to the PVA layer provides efficient moisture barrier properties, hence leading to more reliable and predictable electronic performance^[24,60,61]. Therefore, following the PVA annealing, we deposited a hydrophobic interlayer (UV-PCL) to improve film quality and device reproducibility. The optimal UV-crosslinking conditions were previously determined through solvent-resistance testing using toluene and by measuring the water contact angle before and after rinsing in our previous studies^[24,27]. The interfacial cross-linking between PCL and PVA not only stabilizes the dielectric bilayer by anchoring the PCL film to the underlying PVA matrix^[52,62] but also suppresses polymer aggregation and reduces the density of surface hydroxyl groups that can act as charge-trapping sites during OTFT operation^[63]. The remaining hydroxyl functionalities within the bulk of the PVA contribute to a relatively high dielectric constant (k), while the cross-linked top layer enables orthogonal solution processing for subsequent semiconductor deposition^[64,65]. The dielectric properties of the resulting bilayer dielectric (PVA/UV-PCL) were assessed by impedance spectroscopy, with the findings presented in [Table 1](#). The reported dielectric constant values aligned with the anticipated range for PVA^[22,24,58,66].

P(DPP-TIT) was deposited on the UV-PCL layer by the spin-coating followed by vacuum annealing for 1 h at 50 $^{\circ}\text{C}$. For performance benchmarking, P(DPP-TIT)-based OTFTs were also fabricated using OTS-treated SiO_2 as the gate dielectric, employing an identical device architecture to ensure direct comparison with the degradable OTFTs^[22,58,60,66-68]. Finally, gold contacts were deposited on the semiconducting layer as the

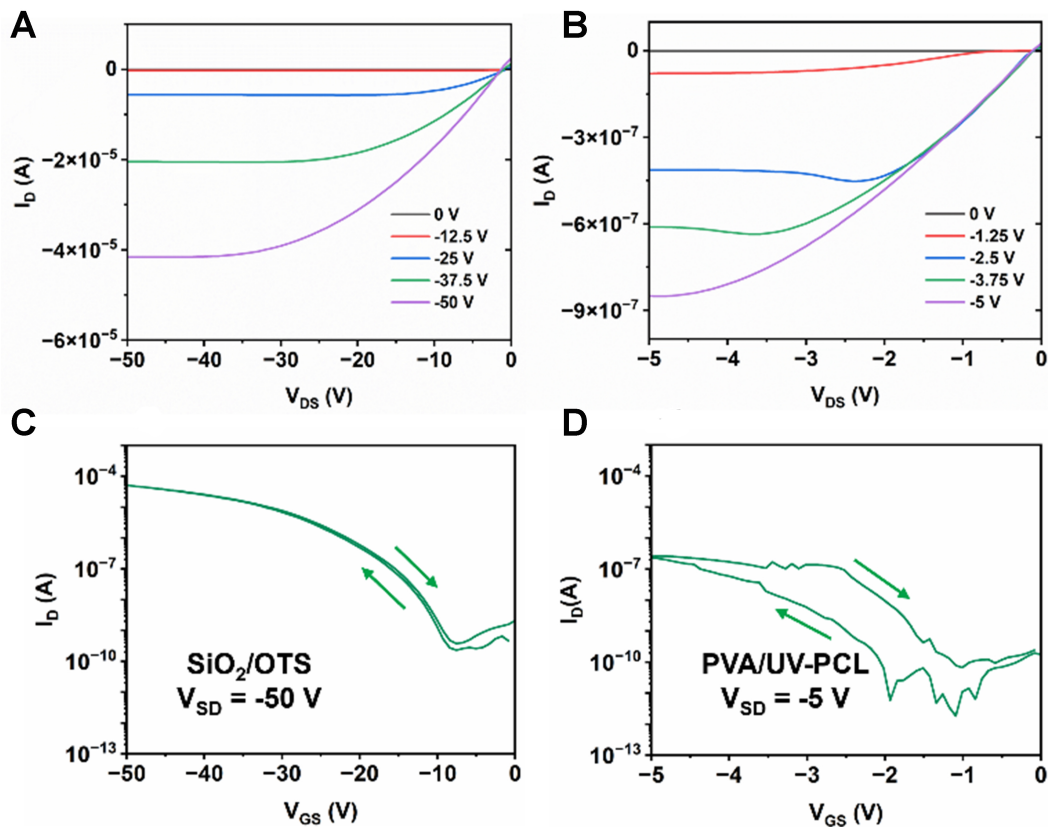


Figure 2. Output curves of (A) SiO₂/OTS and (B) PVA/UV-PCL, and characteristic transfer curves of (C) OTFTs on OTS-treated SiO₂ and (D) on PVA/UV-PCL. The transfer curves vs. V_{GS} were acquired at $V_{DS} = -50$ V and $V_{DS} = -5$ V, respectively. Transfer curves and leakage current are plotted under identical bias conditions for four times for a representative device in the [Supplementary Figure 3](#). OTS: Octyltrichlorosilane; PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone); OTFTs: organic thin-film transistors.

source/drain electrodes. [Figure 2A–D](#) display the characteristic output and transfer curves of both OTFTs. Performance parameters, including field-effect hole mobility (μ_h), V_T , and on/off current ratio ($I_{on/off}$) were extracted to quantify electrical performance [[Table 2](#)]. The V_T of P(DPP-TIT) OTFTs reduced markedly from -16.1 ± 0.9 V on OTS-treated SiO₂ gate dielectrics to -2.0 ± 0.4 V with the application of a PVA/UV-PCL bilayer dielectric. The decrease in V_T indicates less polarity at the semiconductor/dielectric interface, hence mitigating charge trapping [[27,69–71](#)]. This can be attributed to the enhanced dielectric constant of the PVA/UV-PCL bilayer (~ 6.6) in comparison to SiO₂ (3.9) at frequencies under 1 kHz [[72](#)] as well as the elimination of hydroxy group-based charge traps due to the interfacial crosslinking with UV-PCL [[24](#)]. These values represent a significant improvement compared to previous studies [[19](#)] in which PVA was solely employed as a dielectric, yielding V_T values of around -15.4 V for biocompatible and bioresorbable OTFTs. The highest μ_h of the functional OTFT was statistically similar, measuring 0.17 cm²·V⁻¹·s⁻¹ for OTFT made with OTS-treated SiO₂ dielectric and 0.16 cm²·V⁻¹·s⁻¹ for OTFT fabricated with PVA/UV-PCL dielectric. The $I_{on/off}$ for PVA/UV-PCL based devices is low and typical for PVA-based dielectrics [[73](#)]; resulting from the low V_{GS} and V_{SD} needed to operate the device. For example, when the OTFT fabricated with PVA/UV-PCL bilayer dielectric was tested at V_{GS} and $V_{SD} = -5$ V, we obtained approximately 0.85 μ A, but the OTFT made using OTS/SiO₂ dielectric remained inactive under the same conditions, requiring approximately -10 V to obtain the same amount of current. While mild hysteresis is observed in the PVA/UV-PCL OTFTs due to the dielectric environment and interfacial characteristics, these results demonstrate an effective strategy for developing fully biodegradable, high-performing devices. The on-current value was extracted from the output characteristics at $V_{GS} = -5$ V and $V_{DS} = -5$ V. A lower current level (~ 0.2 μ A) is observed in the transfer characteristics measured under the same bias conditions, which can be attributed to transient charge trapping and bias-stress effects commonly observed in polymer dielectric-based field-effect transistors.

Table 2. Summary of the field effect properties of the degradable and non-degradable OTFT

Substrate/gate/dielectric ^a	Mobility (cm ² ·V ⁻¹ ·s ⁻¹)		$I_{on/off}^d$	V_T (V) ^e	n ^e
	μ_{max}^b	μ_{avg}^c			
Si/SiO ₂	0.17	0.08 ± 0.04	10 ⁴	-16.1 ± 0.9	38
PLA/Au/PVA/UV-PCL	0.16	0.03 ± 0.04	10 ³	-2.0 ± 0.4	31

^aOTFT fabricated with a silicon (Si) substrate and SiO₂ dielectric, or OTFT fabricated using a Biodegradable PLA substrate and PVA-based dielectric. Both devices were made using P(DPP-TIT) as the semiconductor. ^bMaximum mobility (μ) measured from the functional OTFT. ^cMobility and threshold voltage were computed using an average value. ^dRatio of the on and off currents was calculated using the median value. ^eNumber of functioning devices used for the calculation of averages. OTFT: Organic thin-film transistor; PLA: poly(lactic acid); PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone); P(DPP-TIT): poly diketopyrrolopyrrole thiophene-imine-thiophene.

In our study, we observe the expected tradeoff between fully green, transiently degradable dielectrics and OTFT performance. Hysteresis mainly originates from slow polarization and charge trapping associated with the polar hydroxyl groups in the PVA dielectric^[24,27]. PVA contains a high density of hydroxyl groups, whose dipoles reorient under the applied gate field but relax on a timescale comparable to, or slower than, the voltage sweep, this time-dependent dipolar polarization makes the channel charge depend on the sweep direction, giving rise to a hysteretic shift and current. Moisture uptake can further facilitate reorientation of hydroxyl groups or introduce additional mobile charges, modifying but not eliminating this hysteresis, while added low-*k* interlayers (e.g., UV-PCL) mainly lower interfacial charge trapping and leakage but do not completely remove the intrinsic dipolar polarization effects^[24,27,28,61]. In a previous study from our group^[27], we showed that hysteresis can be largely suppressed by lowering pulsing frequency, confirming that the dominant contribution is dielectric polarization. In addition, these devices were measured over a much lower voltage range (V_{GS} and $V_{SD} = -5$ V) compared to SiO₂-based devices (V_{GS} and $V_{SD} = -50$ V) to achieve their low-voltage operation, which explains the smaller drain current values. Nevertheless, despite these trade-offs, the devices still exhibit clear transistor behavior with reproducible channel formation at low voltages, demonstrating that the PVA/UV-PCL dielectric system enables functional, low-voltage, transient electronics as intended.

Furthermore, to evaluate short-term bias stability, consecutive transfer characteristics were measured under identical bias conditions. [Supplementary Figure 2A-D](#), depicts the representative transfer curves. The device exhibited minimal variation in extracted parameters over four repeated sweeps [[Supplementary Table 2](#)], indicating stable charge transport and limited bias-induced degradation within the measurement time scale.

We performed numerical simulation to investigate the mechanism of the fabricated P(DPP-TIT) TFTs^[74-78]. Our goal was to reconstruct the transfer characteristics measured under dual-sweep conditions for the devices representative for the non-degradable (SiO₂ dielectric) and degradable (PVA/UV-PCL dielectric) systems. We found that all curve groups measured in the saturation regime reasonably well follow the quadratic I_D - V_G relationship, excluding the Schottky barrier and/or trap effects as a dominant contributor. We therefore took the hole mobility μ_{sim} (intrinsic mobility that serves as a simulation input) and the charge density at the semiconductor/insulator interface N_{int} as main fitting parameters.

[Supplementary Figure 4A and B](#) show the results of optimized simulation fitting to the experimental data. The fitting process yielded μ_{sim} of 0.112 and 0.051 cm²·V⁻¹·s⁻¹ for the non-degradable and degradable devices, respectively. The dual-sweep measurement, conducted in the sequence of off-to-on and on-to-off scans, resulted in a hysteresis in opposite directions to a different extent in the two TFTs. The dynamic shift of the V_T due to the hysteresis was modelled by the modulation of N_{int} in our simulation. As shown in

Supplementary Figure 4C, the degradable TFT showed significantly lower N_{int} values as compared to the non-degradable TFT, confirming the suitability of the P(DPP-TIT) semiconductor–PVA/UV-PCL dielectric combination for low-voltage applications. The small hysteresis of the non-degradable TFT [**Figure 2C**] was tracked by a slight increase in N_{int} between the two scans. The larger and opposite-direction hysteresis of the degradable TFT [**Figure 2D**] was modelled by a decrease in N_{int} , which could originate from slower relaxation associated with charged species in the multi-component PVA/UV-PCL dielectric. N_{int} is the fixed two-dimensional charge density at the semiconductor/insulator interface that either partially screens or reinforces the externally applied gate field. A change in N_{int} therefore induces a systematic lateral shift of the transfer curve [**Supplementary Figure 5**]. This property was used to extract the N_{int} value corresponding to each transfer curve.

Synchrotron-based GIWAXS measurements were used to characterize the molecular packing and crystallographic orientation of the P(DPP-TIT) semiconductor deposited on both SiO_2 and PVA/UV-PCL dielectrics. The corresponding 2D scattering patterns [**Figure 3A and B**] and diffraction profiles [**Supplementary Figure 6**] reveal comparable structural features across both systems. As shown in **Figure 3A**, the diffraction pattern of the semiconductor films deposited on the degradable dielectric includes additional reflections originating from the polymer substrate (PLA) [**Supplementary Figure 7**] which partially overlap with the semiconductor's scattering signal. In contrast, the film deposited on SiO_2 [**Figure 3B**] exhibits sharper and more clearly resolved diffraction spots with higher intensity. To quantify this difference, the integrated intensity of the (100) reflection was extracted from χ -cuts and normalized by film thickness [**Supplementary Figure 8**]. The resulting ratio between the semiconductor film deposited on SiO_2 and on PVA/UV-PCL was 1.11, indicating only a modest increase in the normalized (100) intensity for the SiO_2 sample and suggesting comparable crystallinity across both substrates. Aside from the substrate-related reflections, no significant differences in the overall diffraction pattern were observed [**Supplementary Figure 6**], confirming that the polymer dielectric does not significantly affect the molecular packing or crystallographic texture of the P(DPP-TIT) semiconductor. Moreover, when examined under a 1D line profile plot as per **Table 3** and **Supplementary Figure 9**, both device structures exhibit similar lamellar spacing parameters, indicating that the polymer dielectric substrate offers comparable morphological characteristics when compared to SiO_2/OTS . Notably, however, the lack of the 010π - π spacing peak for P(DPP-TIT) on PVA/UV-PCL dielectric, as quantified in **Table 3**, indicates that P(DPP-TIT) exhibits less observable edge-on π -stacking properties in comparison to on SiO_2/OTS ^[79,80]. This observation is consistent with other organic polymer semiconductors deposited on non-monolayer substrates and polymer dielectrics^[16]. Despite these differences, as per **Table 2**, this has little influence on the μ_h of P(DPP-TIT) itself, overall suggesting that the PVA/UV-PCL dielectric is a good substitute for SiO_2/OTS .

Raman microscopy was employed to gain a deeper understanding of the morphology of P(DPP-TIT) on OTS-treated SiO_2 and PVA/UV-PCL dielectric surface. This technique is highly sensitive to local polymer ordering, permitting subtle variations in conjugation length or miscibility within the material to be detected^[81–84]. By tracking characteristic vibrational peaks specific to the DPP-based semiconductor, chemical or compositional maps can be generated. **Figure 4A** compares Raman spectra for OTFT with P(DPP-TIT) deposited on OTS-treated SiO_2 and on PVA/UV-PCL. Distinct Raman features of the DPP-based semiconductor include the symmetric C=C stretching of the thiophene backbone at $\sim 1,412 \text{ cm}^{-1}$, symmetric C–N and C–C stretches associated with the DPP acceptor at $\sim 1,365 \text{ cm}^{-1}$, and asymmetric C=C stretching from the DPP and thiophene lactam rings at $\sim 1,512 \text{ cm}^{-1}$ [**Figure 4A**]. **Figure 4B and C** depict the Raman intensity maps for $19 \times 19 \mu\text{m}^2$ of an OTFT device fabricated by depositing P(DPP-TIT) on OTS-treated SiO_2 and on a degradable dielectric (PVA/UV-PCL), respectively. These figures demonstrate the normalized intensity value of the DPP-based semiconductor (at $\sim 1,512 \text{ cm}^{-1}$) and provide a visual representation of the chemical uniformity of the P(DPP-TIT) film to complement the Raman spectrum [**Figure 4A**]. Raman maps

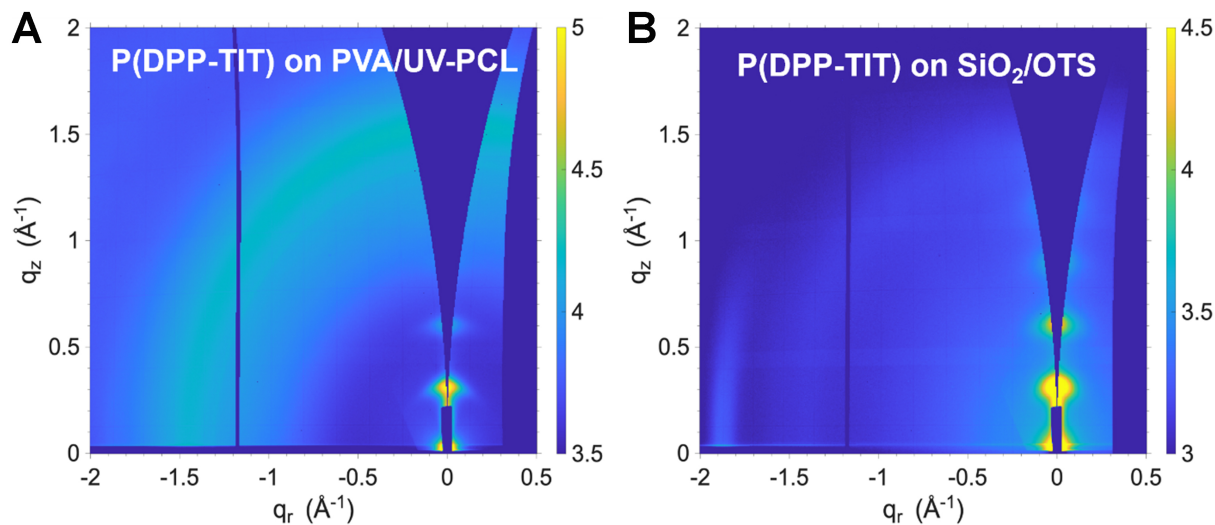


Figure 3. GIWAXS scattering patterns of DPP-imine conjugated polymer thin films deposited on (A) the bilayer dielectric (PVA/UV-PCL) and (B) on SiO₂/OTS. GIWAXS: Grazing-incidence wide-angle X-ray scattering; DPP: diketopyrrolopyrrole; PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone); OTS: octyltrichlorosilane; P(DPP-TIT): poly diketopyrrolopyrrole thiophene-imine-thiophene.

Table 3. Stacking parameters and crystallization data of P(DPP-TIT) on OTS-SiO₂ and degradable polymer substrates

Dielectrics	Lamellar spacing		π - π spacing		FWHM [1/Å]	CCL [Å]
	Peak position [1/Å]	d-d distance [Å]	Peak position [1/Å]	d-d distance [Å]		
SiO ₂ /OTS	0.247	25.438	1.75	3.590	0.101	55.988
PVA/UV-PCL	0.255	24.640	n/a	n/a	n/a	n/a

CCL was calculated using the Scherrer equation with a correction factor (K) of 0.9. P(DPP-TIT): Poly diketopyrrolopyrrole thiophene-imine-thiophene; OTS: octyltrichlorosilane; FWHM: full width at half maximum; CCL: crystal coherence length; PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone).

reveal that the intensity of P(DPP-TIT) on PVA/UV-PCL dielectric is relatively more uniform than when deposited on OTS-treated SiO₂. A more packed and uniform structure of P(DPP-TIT) on a degradable dielectric surface can be attributed to fewer deep interfacial traps at the dielectric/semiconductor interface, enabling a more continuous conjugated network.

The effect of the degradable polymer substrate and dielectric on the thin-film morphology was further characterized by AFM. Thin films were cast via spin-coating onto the bilayer dielectric (PVA/UV-PCL) [Figure 4D] and on OTS-treated SiO₂ [Figure 4E] and were imaged over a 20 × 20 μm² area to evaluate large-scale surface features. In both cases, P(DPP-TIT) exhibited morphological characteristics typical of DPP-based semiconductors, with uniform grain-like domains and no evidence of phase separation or aggregation^[85,86]. The root-mean-square (RMS) roughness was 2.97 nm for the polymer substrate and 2.86 nm for SiO₂, indicating comparable surface topographies. This similarity in morphology suggests that the dielectric and substrate have a minimal influence on the thin-film formation, which is consistent with the negligible difference in charge-carrier mobility between the devices^[87,88]. The AFM results are in good agreement with the Raman spectra [Figure 4A] and corresponding Raman mapping [Figure 4B and C], collectively confirming the uniformity and compositional consistency of the film. These results confirm that the semiconductor can be integrated into a fully biodegradable platform while maintaining its thin-film morphology.

As depicted in Figure 1B, exposure of the fabricated OTFT to acidic medium (1 M HCl) for 7 days led to the degradation of P(DPP-TIT) layer and possibly the dissolution of bilayer dielectric layer based on PVA, while

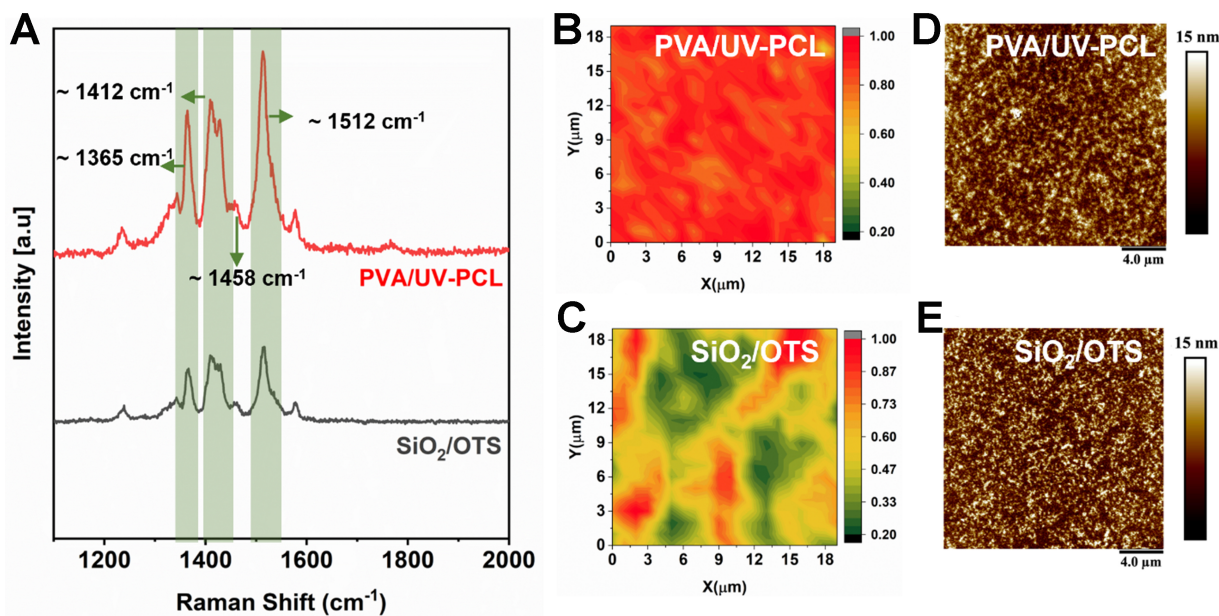


Figure 4. Raman spectra (A) and maps ($19 \times 19 \mu\text{m}^2$) (B and C) of degradable P(DPP-TIT) semiconductor on bilayer dielectric (PVA/UV-PCL) and OTS-treated SiO₂. $20 \times 20 \mu\text{m}$ AFM topography images of thin films of P(DPP-TIT) deposited on (D) the degradable polymer dielectric and (E) OTS-treated SiO₂. P(DPP-TIT): Poly diketopyrrolopyrrole thiophene-imine-thiophene; PVA: poly(vinyl alcohol); UV: ultraviolet; PCL: poly(caprolactone); OTS: octyltrichlorosilane; AFM: atomic force microscopy.

subsequent immersion of the degradable PLA substrate and patterned gold coated gate electrode in basic buffer solution (pH ~ 10) resulted in the gradual degradation of the PLA matrix in 20 days, leaving behind only dispersed gold micro and nanoparticles. This combination of structural design and sequential degradation demonstrates the feasibility of fabricating a high-performance yet transient OTFT system using biodegradable materials. UV-Vis spectroscopy was employed to track the degradation of imine groups in the P(DPP-TIT) polymers thin film [Figure 5]. The films were submerged in 1 M HCl at specified time intervals of 15 min, 30 min, and 1 h, upon which the spectral data was collected, as per Figure 5A. Progressive cleavage of the imine bonds results in the depolymerization of the material into oligomeric and monomeric species, which exhibit negligible absorption in the visible spectrum^[18,36,43]. This can be observed in Figure 5B, by the progressive decrease in absorbance of the λ_{0-1} after just 15 min of submersion, as well as an observable widening hyperchromic shift, indicating polymer chain scission^[16]. The absorbance continues to decrease more drastically after 30 min, and by 1 h, only approximately 20% of the initial λ_{0-1} absorbance remains, suggesting that the solid-state film of P(DPP-TIT) can undergo rapid depolymerization under aqueous acidic conditions. In comparison with previously established reports of the degradation of P(DPP-TIT) based thin films, this variant of P(DPP-TIT) has a degree of polymerization of 11 repeat units, and relatively narrow dispersity of 1.55, as per Supplementary Table 1. Both values are indicative that P(DPP-TIT) has a relatively low molecular weight, with polymer chains having relatively similar lengths^[89]. The combination of these factors can provide faster degradation in comparison to previously established polymers possessing similar alkyl chains and conjugated backbones^[43]. This is noteworthy, as literature reports indicate that polymers with reduced molecular weights degrade more readily, which complements the other components of the OTFT system that are also engineered for rapid breakdown^[90,91]. Together, these design features ensure that the material maintains strong charge transport characteristics during operation while facilitating efficient degradation after use. Notably, as shown in Figure 5A, the π - π^* transition peak centered at 450 nm associated with intrachain charge delocalization diminished at a slower rate in comparison to λ_{0-1} and λ_{0-0} absorbance peaks. The decay in absorbance of this peak is associated with the hydrolysis and subsequent ring-opening of the DPP motif^[41]. With these observations, we hypothesize that in the solid state, the polymer undergoes

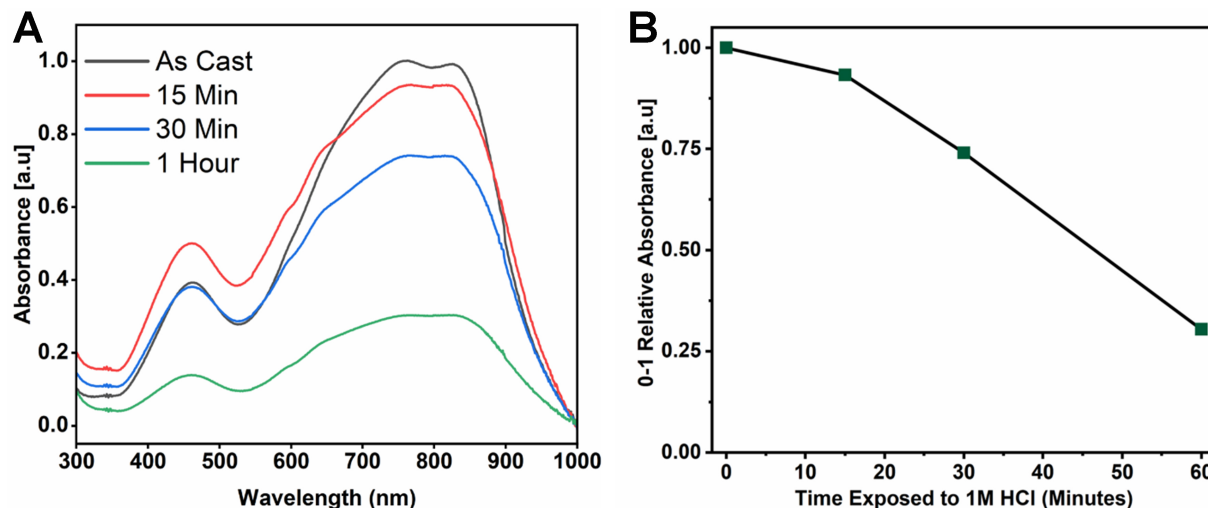


Figure 5. (A) UV-Vis spectra of the λ_{0-1} -based normalized absorbance of P(DPP-TIT) thin films on quartz substrates upon submersion in aqueous 1 M HCl solution at selected time intervals; (B) Line plot of UV-Vis spectra quantifying the decrease in λ_{0-1} over a period of 1 h (60 min). UV: Ultraviolet; P(DPP-TIT): poly diketopyrrolopyrrole thiophene-imine-thiophene.

chain scission via hydrolysis of the imine bonds within the conjugated backbone, which is then followed by destruction of the DPP motif itself^[92].

We have also investigated the full device degradation and component recovery leveraging dual trigger dissolution: the imine-containing DPP-based semiconductor degrades under acidic conditions^[43], while the PLA substrate dissolves in basic environments^[24,93], enabling sequential separation and extraction of device layers. To demonstrate the degradation of the degradable P(DPP-TIT) semiconductor, a device was immersed in 1 M HCl solution and monitored for 7 days. Raman microscopy performed after exposure revealed the complete disappearance of the typical DPP polymer semiconductor peaks, as per [Figure 6A](#), associated with the delocalized conjugated backbone alkene and aromatic spectral signatures. There was also a weak vibration peak observed at $\sim 1,458 \text{ cm}^{-1}$, which can be assigned to O-H and C-H bending for PVA film^[94] [[Figure 6A](#)]. Hence, the disappearance of characteristic peaks of P(DPP-TIT) and PVA confirms that the active semiconductor layer was fully degraded along with full dissolution of the thin bilayer dielectric. Subsequently, the remaining layers (PLA substrate and gate electrode) were immersed in a basic buffer solution with a pH of ~ 10 to facilitate degradation. Raman measurements following this treatment displayed no characteristic peaks of PLA, yielding a flat baseline, which indicates that all the OTFT layers, including the P(DPP-TIT) semiconductor, substrate (PLA), and dielectric (PVA/UV-PCL), were completely degraded, leaving micro/nano particles of gold. The corresponding optical images shown in [Figure 6B-D](#) depict the stepwise degradation process of the OTFT device in an acidic and basic medium. [Figure 6B](#) shows the intact device prior to immersion. [Figure 6C](#) demonstrates the complete degradation of the active semiconducting layer and dissolution of PVA and UV-PCL (monolayer), along with the visible disintegration of the source and drain electrodes during immersion. Finally, [Figure 6D](#) reveals the presence of only gold micro/nanoparticles remaining after the complete degradation of the substrate in basic buffer solution of NaOH (pH ~ 10). Similarly, [Figures 6E-G](#) illustrate the degradation sequence for the free-standing OTFT structure. [Figure 6E](#) shows an OTFT device before it was immersed in 1 M HCl, [Figure 6F](#) displays the free-standing PLA layer with the remaining gate electrode pattern, and [Figure 6G](#) shows a free-standing gold particle following substrate degradation. Overall, these results and images clearly demonstrate a tiered degradation approach which enables separation of components and will facilitate separation, recovery and repurposing of the OTFT components.

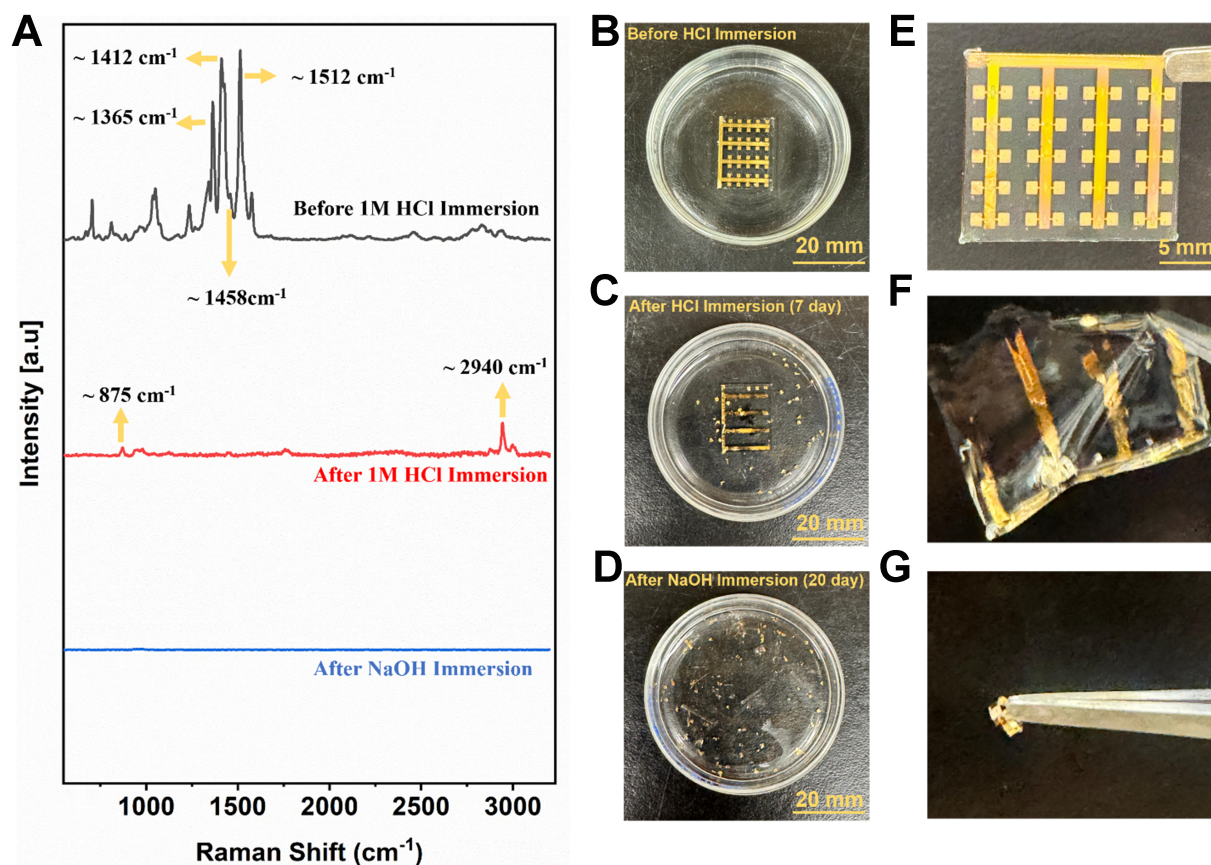


Figure 6. (A) Raman spectrum of the degradable OTFT device at different stages of degradation; (B-D) Photos of OTFTs before the immersion in 1 M HCl, after immersion in 1 M HCl, and after the immersion in basic buffer solution (pH -10), respectively; (E-G) Free-standing images of OTFT before the immersion in 1 M HCl, after immersion in 1 M HCl, and after the immersion in basic buffer solution, respectively. OTFT: Organic thin-film transistor.

Furthermore, the acid and base media employed in this work for the demonstration of sequential degradation are not intended to represent physiological or typical environmental conditions. Instead, they serve as accelerated conditions used to demonstrate selective layer removal and identify relative material stability within experimentally accessible time scales^[37,93,95-97]. In potential industrial recovery or recycling scenarios, similar acceleration could be achieved through elevated temperatures and controlled pH to facilitate efficient material separation. Under natural environmental conditions, degradation would instead proceed more gradually through hydrolytic, enzymatic, or environmentally assisted processes. Over time, the material breaks into soluble fragments, supporting separation and reducing long-term persistence. Accordingly, the presented strategy demonstrates the feasibility of controlled disassembly while recognizing that degradation in real-world environments would occur at slower rates than those observed under accelerated laboratory conditions.

CONCLUSION

In summary, biocompatible and fully biodegradable OTFTs were prepared using an imine-based degradable semiconducting polymer P(DPP-TIT), coupled with a biodegradable substrate (PLA) and dielectric (PVA/UV-PCL). The use of a bilayer gate dielectric effectively reduced the V_T of P(DPP-TIT)-based *p*-type OTFTs from -16.1 to -2 V while maintaining electrical performance comparable to OTFTs employing conventional SiO₂ dielectrics. Raman spectroscopy/microscopy, GIWAXS, and AFM analyses revealed similar morphological and structural characteristics consistent with the observed device performance. Finally,

we demonstrated the stepwise degradation of each device layer under acidic and basic environments, confirming the complete disintegration of the OTFT components. This work highlights a promising approach toward sustainable, transient electronics that combine reliable functionality with environmental degradability.

DECLARATIONS

Acknowledgments

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Authors' contributions

Conducted the experimental work including device fabrication, degradation experiments, data analysis, and wrote the initial draft of the manuscript: Ali, M.

Synthesized the semiconducting polymer, conducted UV-Vis, and assisted in data analysis and editing of the manuscript: Nyayachavadi, A.

Conducted experiments and assisted in data analysis: Pascual, S. G.

Performed numerical simulation analysis: Park, J.

Analysed numerical simulation data and edited the manuscript: Kim, C. H.

Performed the GIWAXS and collected the data: Hemmerle, A.

Helped design and created schematic figures and edited the manuscript: Manion, J. G.

Acquired funding, managed supervision, directed the study, and assisted in writing and editing the manuscript: Lessard, B. H.

The manuscript was written through the contributions of all authors. All authors have given approval to the final version of the manuscript.

Availability of data and materials

The data supporting the findings of this study are available in the article and its [Supplementary Materials](#). All other reasonable requests can be directed to the corresponding author.

AI and AI-assisted tools statement

Not applicable.

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Conflicts of interest

All authors declared that there are no conflicts of interest.

Ethical approval and consent to participate

Not applicable.

Consent for publication

Not applicable.

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Supplementary Materials

[Supplementary Materials](#)

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